

A -

- B -

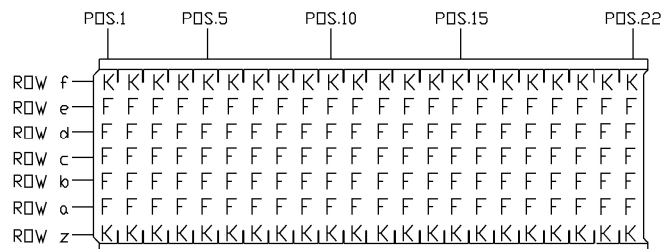
d-

D -

- E -

A1版

SELECTIVE LOADING PATTERN



SELECTIVE LOADING CHART				
PIN CODE	MATING LENGTH OF CONTACTS			CONTACT TAIL LENGTHS
	SIGNAL	ALL	GROUND	
	M	P	N	
F	.268/6.80	.382/9.70	N/A	.630/16.00
K	.327/8.30	.441/11.20	.327/8.30	.630/16.00

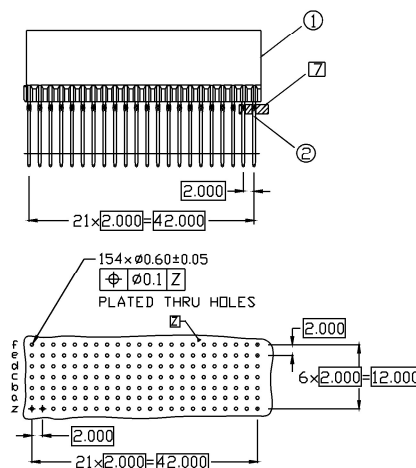
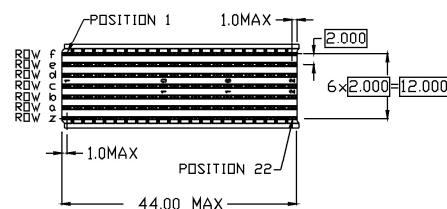


Diagram illustrating the dimensions and material specifications for a circular pad on a Printed Circuit Board (PCB):

- PRINTED CIRCUIT BOARD DIELECTRIC MATERIAL**: Points to the outer circular region.
- Ø0.680-0.720 DRILLED HOLE**: Points to the central hole.
- 0.025 MIN COPPER THICKNESS**: Points to the copper layer on the pad.
- Ø0.550-0.650 FINISHED HOLE**: Points to the inner circular region.
- 0.010 MAX SOLDER THICKNESS**: Points to the solder layer on the pad.

COMPLIANT CONTACT

Max.Insertion Force(per contact): 22.5 lbs./100 N
Min. Retention force(per contact): 4.5 lbs./20 N

DESIGN UNITS ☒ mm ☐ INCH			NAME: 2MM HEADER B TYPE		 NEXTRONICS ENGINEERING CORP.		
GENERAL TOLERANCES: (UNLESS SPECIFIED)			PART NO: NX5B0BA26X04CA		TITLE: CUSTOMER DWG		C
	mm	INCH	APDP: 楊海文 8/23/10		DWG. NO: 010-0000-722-NX5B0BA26X04CA		
4 PLACE	± 0.05	± .**	CHKD: 廖小瓊 8/23/10		1 / 1		
3 PLACE	± 0.10	± .**	DRAWN: 何潔賢 8/23/10		SCALE: 1 / 1		
2 PLACE	± 0.20	± .**			SHEET: 1 / 1		
1 PLACE	± 0.30	± .**			REV.: A		
ANGULAR: X° ± .** X° ± .**							